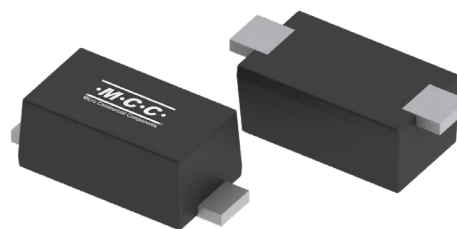


200W Transient Voltage Suppression Diode

Features

- 200W peak pulse power capability at 10/1000 μ s waveform,
- Transient protection:
 - IEC 61000-4-2 (ESD) \pm 30kV (Air), \pm 30kV (Contact)
- Uni-directional TVS protection
- Reverse working voltage, V_{RWM} : 3.3V
- Excellent clamping capability
- Low leakage current



SOD-123FL



Applications

- Hard drives
- Notebooks
- POS terminal
- SSDs

Mechanical Data

- Package: SOD-123FL
- Moisture Sensitivity Level 1, per J-STD-020
- Halogen Free. "Green" Device ^(Note1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Body Marking and Pin Layout

Marking Code	Simplified Outline	Internal Structure
	<p>Transparent top view</p>	<p>Uni-directional</p>

Ordering Information

Product Name	Reel Size	Packing Type	Qty/Reel
SMF3.3A-TP	7"	Tape & Reel	2,500

For packaging details, visit our website at <https://www.mccsemi.com/Package/List>

200W Transient Voltage Suppression Diode

Maximum Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Rating	Unit
Peak Pulse Power Surge Current with a 10/1000 μs Waveform (Note 2)	I_{PPM}	See Next Table	A
Peak Pulse Power Dissipation (Note 2)	P_{PPM}	200	W
Power Dissipation on Infinite Heat Sink, $T_A=25^{\circ}\text{C}$	P_D	1	W
Maximum instantaneous forward voltage at 1A	V_F	1.5	V
Peak Forward Surge Current (Note3)	I_{FSM}	30	A
Operating Junction Temperature Range	T_J	-55 to 150	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-55 to 150	$^{\circ}\text{C}$

- Note:
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and 1000ppm antimony compounds.
 2. Non-repetitive current pulse per Fig.3 and derated above $T_A=25^{\circ}\text{C}$ per Fig.4.
 3. Measured on 8.3ms single half sinewave or equivalent square wave, duty cycle = 4 pulses per minute maximum.

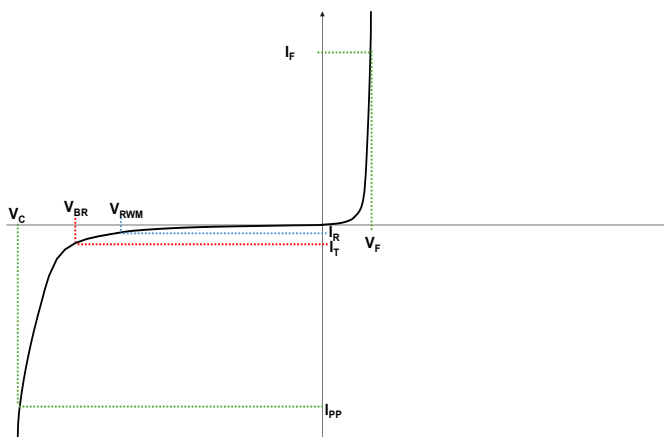
Thermal Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Rating	Unit
Thermal Resistance from Junction to Ambient (Note 4)	$R_{\theta JA}$	120	$^{\circ}\text{C/W}$
Thermal Resistance from Junction to Lead	$R_{\theta JL}$	30	$^{\circ}\text{C/W}$

- Note:
4. Mounted on 0.2x 0.2" (5.0x 5.0 mm) copper pads to each terminal.

Parameter Definition

Symbol	Parameter
V_{RWM}	Peak Reverse Working Voltage
I_R	Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
P_{PPM}	Peak Pulse Power Dissipation
C_J	Junction Capacitance
I_F	Forward Current
V_F	Forward Voltage @ I_F



Electrical Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reverse Working Voltage	V_{RWM}				3.3	V
Reverse Breakdown Voltage	V_{BR}	$I_T=10\text{mA}$	5.2		6.5	V
Reverse Leakage Current	I_R	$V_{RWM}=3.3\text{V}$			150	μA
Forward Voltage	V_F	$I_F=1\text{mA}$			1.2	V
Clamping Voltage (Note3)	V_C	$I_{PP}=27.4\text{A}$, $t_p=10/1000\mu\text{s}$			8	V
Junction Capacitance	C_J	$V_R=0\text{V}$, $f=1\text{MHz}$		2.3	3.0	nF

200W Transient Voltage Suppression Diode

Curve Characteristics

Fig.1-Peak Pulse Power Rating Curve

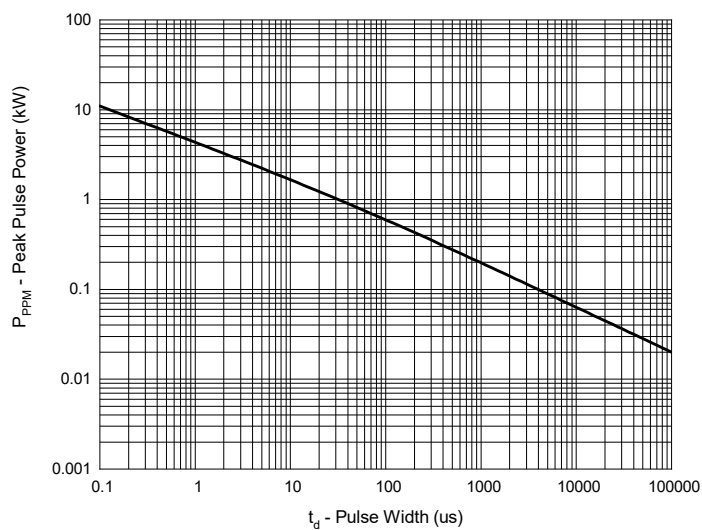


Fig. 2 - Typical Junction Capacitance

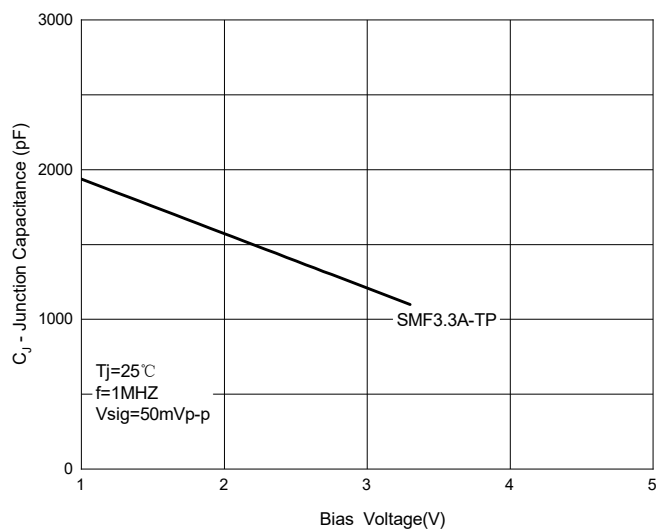


Fig. 3 - Pulse Waveform

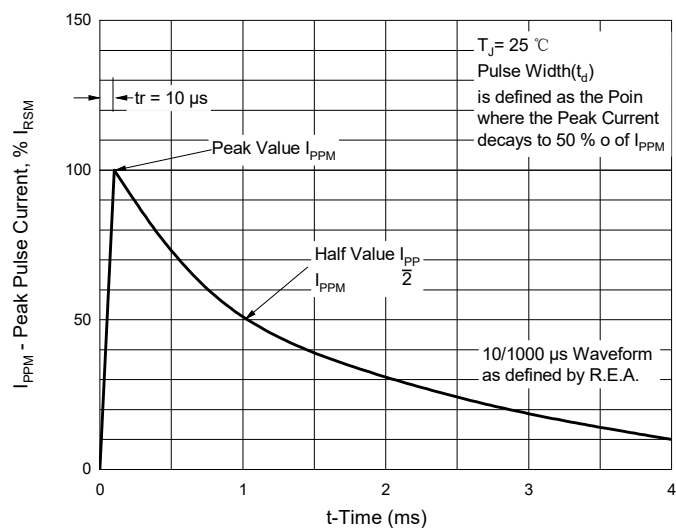
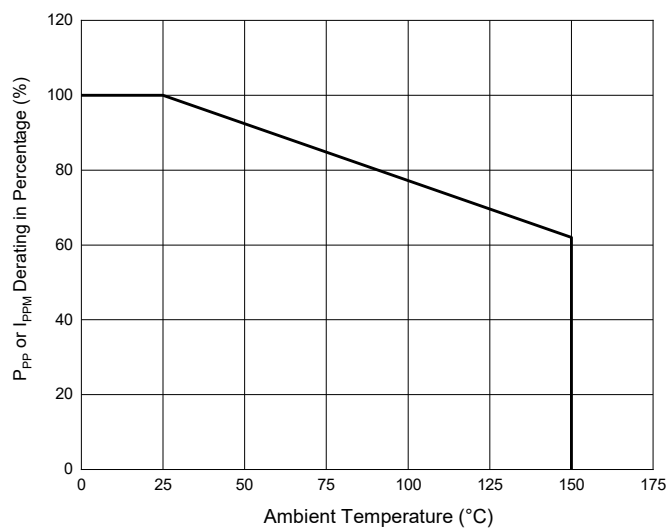
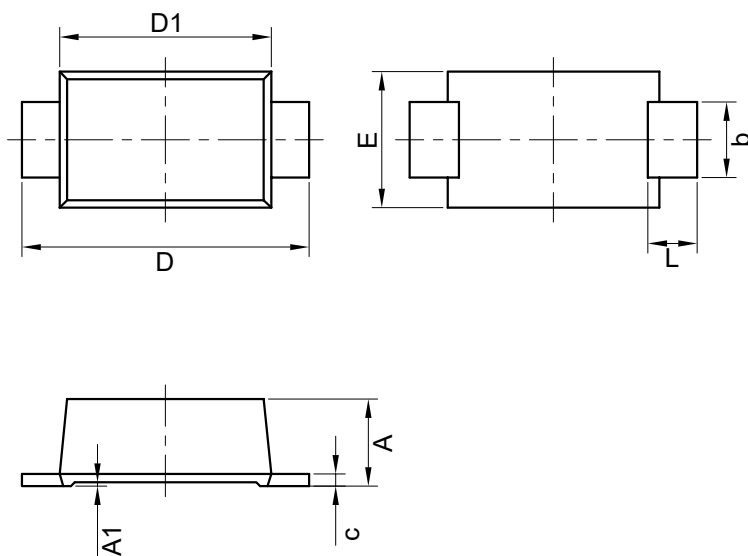


Fig. 4 - Pulse Derating Curve

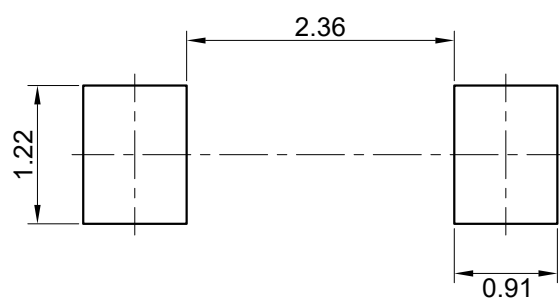


Package Outline



DIM	INCH		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.035	0.047	0.90	1.20	
A1	0.000	0.004	0.00	0.10	
b	0.032	0.047	0.80	1.20	
c	0.004	0.010	0.10	0.25	
D	0.138	0.154	3.50	3.90	
D1	0.100	0.114	2.55	2.90	
E	0.063	0.075	1.60	1.90	
L	0.016	0.035	0.40	0.90	

Suggested Pad Layout (Unit:mm)



Notes:

1. The suggested land pattern dimensions have been provided for reference only.
2. For further information, please refer to document IPC-7351.

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